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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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## 2A, 200V Surface Mount Ultra Fast Rectifier

### FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Low profile package
- Super fast recovery time for high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

### APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Monitor
- TV

### MECHANICAL DATA

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Part no. with suffix "H" means AEC-Q101 qualified
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.09 g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$I_{F(AV)}$	2	A
$V_{RRM}$	200	V
$I_{FSM}$	50	A
$T_{JMAX}$	150	°C
Package	DO-214AA (SMB)	
Configuration	Single Die	



**DO-214AA (SMB)**

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	ES2DV	UNIT
Marking code on the device		ES2DV	
Repetitive peak reverse voltage	$V_{RRM}$	200	V
Reverse voltage, total rms value	$V_{R(RMS)}$	140	V
Maximum DC blocking voltage	$V_{DC}$	200	V
Forward current	$I_{F(AV)}$	2	A
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	$I_{FSM}$	50	A
Junction temperature	$T_J$	- 55 to +150	°C
Storage temperature	$T_{STG}$	- 55 to +150	°C

<b>THERMAL PERFORMANCE</b>			
<b>PARAMETER</b>	<b>SYMBOL</b>	<b>LIMIT</b>	<b>UNIT</b>
Junction-to-lead thermal resistance	$R_{\theta JL}$	25	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	75	°C/W

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^\circ\text{C}$ unless otherwise noted)					
<b>PARAMETER</b>	<b>CONDITIONS</b>	<b>SYMBOL</b>	<b>TYP</b>	<b>MAX</b>	<b>UNIT</b>
Forward voltage per diode <sup>(1)</sup>	$I_F = 2\text{A}, T_J = 25^\circ\text{C}$	$V_F$	-	0.9	V
Reverse current @ rated $V_R$ per diode <sup>(2)</sup>	$T_J = 25^\circ\text{C}$	$I_R$	-	10	$\mu\text{A}$
	$T_J = 150^\circ\text{C}$		-	350	$\mu\text{A}$
Junction Capacitance	1 MHz, $V_R = 4.0\text{V}$	$C_J$	25	-	pF
Reverse recovery time	$I_F = 0.5\text{A}, I_R = 1.0\text{A}$ $I_{RR} = 0.25\text{A}$	$t_{rr}$	-	20	ns

**Notes:**

1. Pulse test with  $PW = 0.3\text{ ms}$
2. Pulse test with  $PW = 30\text{ ms}$

<b>ORDERING INFORMATION</b>					
<b>PART NO.</b>	<b>PART NO. SUFFIX</b>	<b>PACKING CODE</b>	<b>PACKING CODE SUFFIX(*)</b>	<b>PACKAGE</b>	<b>PACKING</b>
ES2DV	H	R5	G	SMB	850 / 7" Plastic reel
		R4		SMB	3,000 / 13" Paper reel
		M4		SMB	3,000 / 13" Plastic reel

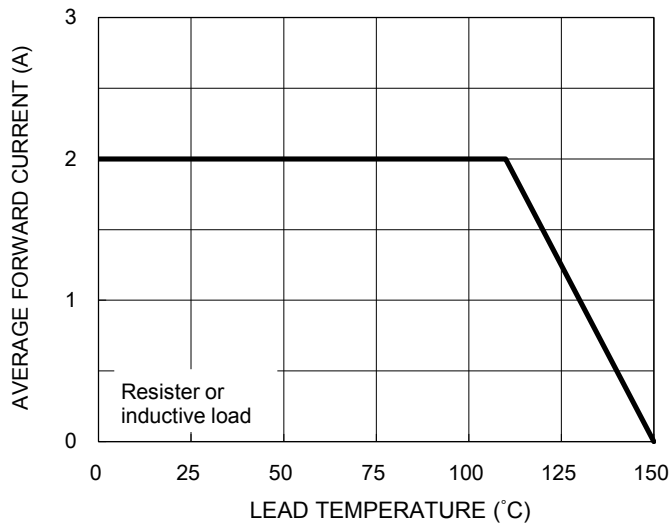
\*: Optional available

<b>EXAMPLE P/N</b>					
<b>EXAMPLE P/N</b>	<b>PART NO.</b>	<b>PART NO. SUFFIX</b>	<b>PACKING CODE</b>	<b>PACKING CODE SUFFIX</b>	<b>DESCRIPTION</b>
ES2DVHR5G	ES2DV	H	R5	G	AEC-Q101 qualified Green compound

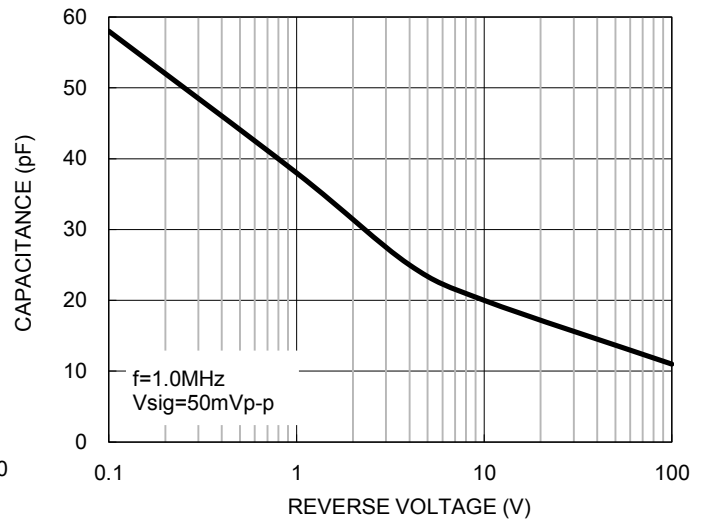
**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

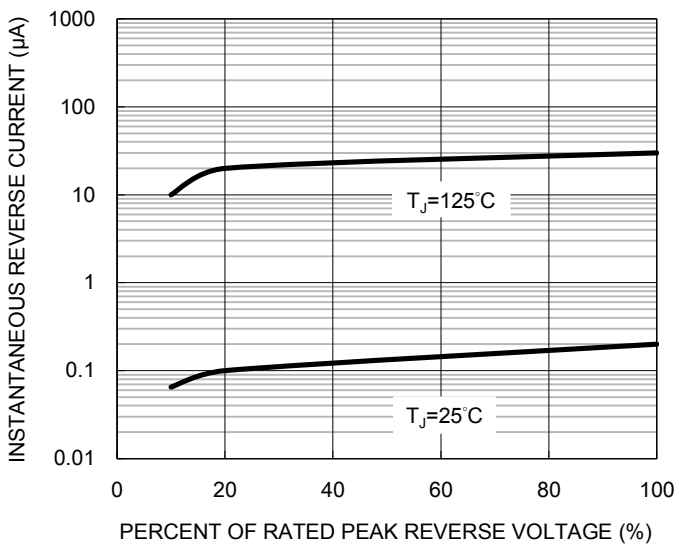
**Fig1. Forward Current Derating Curve**



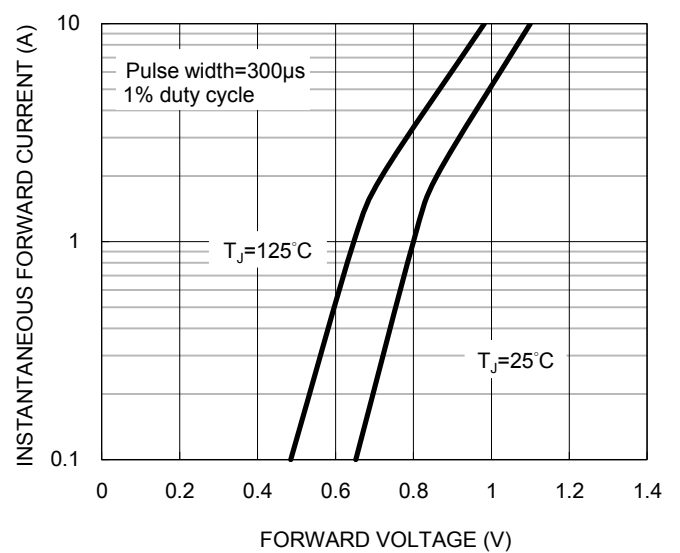
**Fig2. Typical Junction Capacitance**



**Fig3. Typical Reverse Characteristics**

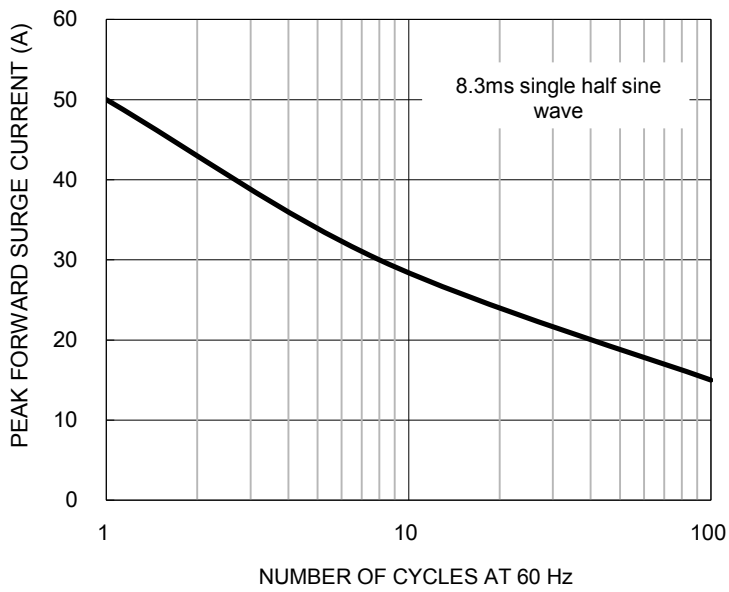


**Fig4. Typical Forward Characteristics**



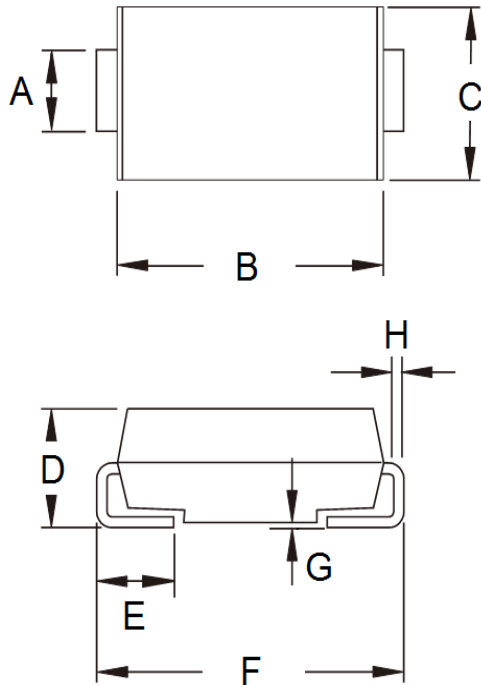


**Fig5. Maximum Non-repetitive Forward Surge Current**



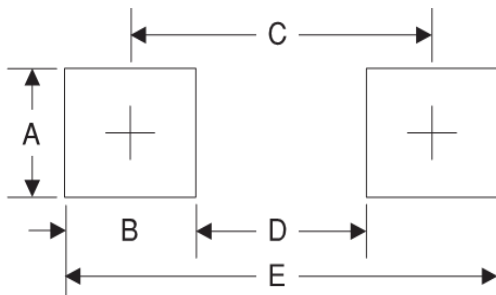
**PACKAGE OUTLINE DIMENSIONS**

DO-214AA (SMB)



DIM.	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	1.95	2.20	0.077	0.087
B	4.05	4.60	0.159	0.181
C	3.30	3.95	0.130	0.156
D	1.95	2.65	0.077	0.104
E	0.75	1.60	0.030	0.063
F	5.10	5.60	0.201	0.220
G	0.05	0.20	0.002	0.008
H	0.15	0.31	0.006	0.012

**SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
A	2.3	0.091
B	2.5	0.098
C	4.3	0.169
D	1.8	0.071
E	6.8	0.268

**MARKING DIAGRAM**



P/N = Marking Code  
G = Green Compound  
YW = Date Code  
F = Factory Code

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